## Supporting Information

## Thermal Release Transfer of Organic Semiconducting Film for

## High-performance Flexible Organic Electronics

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Figure S1. POM images of the DPP-DTT film which was spin coated directly on the Si substrate.



Figure S2. POM images of the DPP-DTT film which was transferred onto PMMA-coated PET substrate.



Figure S3. AFM morphologies of the DPP-DTT films. (a) The film was first spin coated on Si substrate and then transferred onto PMMA-coated PET substrate. (b) The film was directly spin coated on PMMA-coated PET substrate. (c) The film was spin coated on PTFE template and then transferred onto PMMA-coated PET substrate. AFM image was obtained after 1000 cycles' bending operation of this transferred film.



Figure S4. The fabrication of PTFE template on silicon substrate.